Board Shark



www.boardsharkpcb.com

Board Shark 2808C NE 65th Ave Vancouver, WA 98683 USA (503)351-5424 direct carl@boardsharkpcb.com

HDI Capabilities

• Laser via structure: Stack / Step / Skip

• Thinnest Dielectric: .002"

• Thickest Dielectric: .0045"

• Smallest Trace: .0015"

• Smallest Space: .0015"

Sequential Build-Up (SBU): ALIVH (any layer)

Outer layer smallest

Laser via pad: .007"

• Inner layer smallest

Laser via pad: .009"

• Smallest via (laser): .002"

Any Layer Interstitial Via Hole (ALIVH)

Laser Direct Imaging

Laser Drill and Mechanical Drill

HDI and Advanced

Advanced Capabilities

 Probe Cards, DUTs, load boards, burn-in boards 50+ layers, high aspect ratio, metal substrate, substrate PCB with .0015" trace/space, flex and rigid-flex circuits, hybrid construction

Laser cut cavity

Max Board Size: 21x31" multilayer, Up to 48" 1L-2L

Max thickness: .500"

Min annular ring: .0015 / .0015"

Max Cu 35ozSmallest Mech. Hole: .003"

VIPPO: Via-In-Pad-Plated-Over

Layer Count: 88 Layers

• Aspect Ratio: 30:1

 ENEPIG, ENIG, Immersion silver, Immersion tin, OSP, Carbon Ink, HASL, Lead-Free HASL, Hard Gold

• 370HR, polyimide, FR408, Rogers materials, Arlon, Taconic, Megtron, TUC

Ask us about equivalent materials for cost savings!

• Direct bonded copper, Iceberg Copper, Extreme Copper

Save Time, Increase Profits!